

SOT883B

plastic, leadless ultra small plastic package; 3 solder lands; 0.35 mm pitch; 1.0 mm x 0.6 mm x 0.37 mm body

23 August 2017

Package information

1. Package summary

Terminal position code B (bottom)

Package type descriptive code DFN1006B-3

Package type industry code DFN1006B-3

Package style descriptive code SOT (small outline transistor)

Package body material type P (plastic)

Mounting method type S (surface mount)

Issue date30-6-2011Manufacturer package codeSOT883

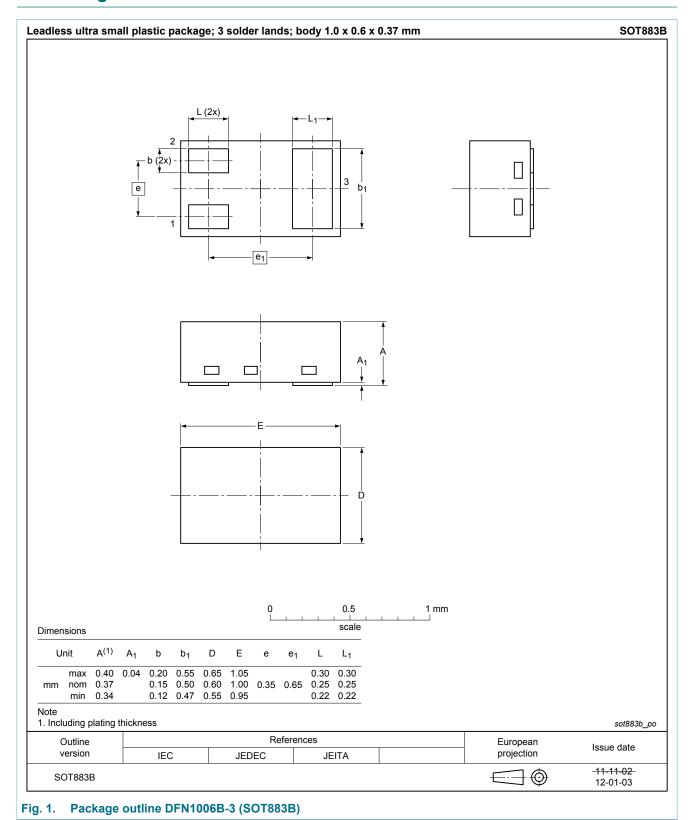
Table 1. Package summary

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	0.55	-	0.6	0.65	mm
E	package width	0.95	-	1	1.05	mm
Α	seated height	0.34	-	0.37	0.4	mm
е	nominal pitch	-	-	0.35	-	mm
n_2	actual quantity of termination	-	-	3	-	



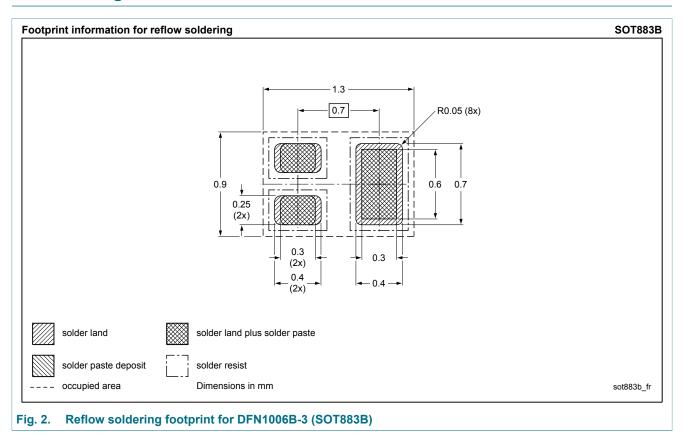
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2. Package outline



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3. Soldering



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4. Legal information

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